COMBINED DECLARATION FOR A PATENT APPLICATION AND POWER OF ATTORNEY

As the below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

PROCESS FOR THE PHYSICAL DEPOLYMERIZATION OF GLYCOSAMINOGLYCANES AND PRODUCTS OBTAINED THEREFORM

GLY	COSAN	MNOGLYCANES AND PR	ODUCIS OBTAINED THE	DI 014.1
the specificat	ion of v	which:		
(check one)	[] [X]	is attached hereto. was filed as United States A on November 7, 2005 and	Application No. 10/555,897 was amended November 7, 2 (if application No. 10/555,897)	
I hereby state specification	e that I , includ	have reviewed and understan ing the claims, as amended b	d the contents of the above-iden y any amendment referred to ab	tified ove.
I do not known publication is application.	w and d n any c	to not believe that the invention the ountry before my invention the	on was ever patented or describe hereof or more than one year pri	ed in any printed for to this
I do not kno States of An	w and d nerica n	lo not believe that the inventi- nore than one year prior to th	on was in public use or on sale i is application.	n the United
I acknowled application i	ge the d	luty to disclose information we dance with Title 37, Code of	which is material to the examinat Federal Regulations, § 1.56.	ion of this
application(s	s) for paication	atent or inventor's certificate	tle 35, United States Code, § 11 listed below and have also ident ficate filed by me on the same such priority is claimed:	ined below any
			•	Priority Claimed
0307638	8.2	<u>EUROPE</u>	9 May 2003	_ [X] []
(Numb		(Country)	(Day/Month/Year filed)	Yes No

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:							
(Number)	(Day/Month/Year filed)						

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States Patent application(s), or under § 365(c) of any PCT international applications designating the United States listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or international application(s) in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

PCT/EP2004/050723 (Application Serial No.)	6 May 2004 (Filing Date)	pending (this application) (Status:patented/pending/abandoned)
I hereby appoint:	Leon R. Yankwich Thomas R. Berka David G. O'Brien Michael R. Wesolowski	Registration No. 30,237 Registration No. 39,606 Registration No. 46,125 Registration No. 50,944

and the firm of Yankwich & Associates, P.C., 201 Broadway, Cambridge, MA 02139 as my attorneys, with full authority to prosecute this application and to transact all business before the U.S. Patent and Trademark Office connected therewith.

Send all official correspondence to: Leon R. Yankwich, Esq.

Yankwich & Associates, P.C.

201 Broadway

Cambridge, MA 02139

Direct telephone calls to: Leon R. Yankwich, Esq.

telephone: (617) 374-3700 telecopier: (617) 374-0055 I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made in the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full name of first inventor	
First inventor's signature	18,02.06
	date
Residence Santhià (VC), ITALY	
Citizenship ITALY	
Post Office Address Via G. Carducci, 8, I-13048 Santhià (VC), ITALY	
Full name of second inventor Donata BENSI	
1.10	
Second inventor's signature	13/09/01
Second inventor's signature	date
Residence Vercelli, ITALY	
Citizenship ITALY	
Post Office Address Via XX Settembre, 18, I-13100 Vercelli, ITALY	
Full name of third inventor Elena VISMARA	
I dil name of diffe inventor	
mit it is a la d'amatana	
Third inventor's signature	date
Residence Milano, ITALY	
Citizenship ITALY	
Post Office Address Via G. Colombo, 81/A, I-20133 Milano, ITALY	

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made in the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full name of first inventor Luigi DE AMBROSI	
First inventor's signature	
Paridanas Conthià (VC) ITALV	date
Residence Santhià (VC), ITALY Citizenship ITALY	
Post Office Address Via G. Carducci, 8, I-13048 Santhià (VC), ITALY	
10st Office Madross Via G. Garden, 6, 1 120 to Samuel Via A. Carlotte Via G. Garden, 6, 1 120 to Samuel Via A. Carlotte Via G. Garden, 6, 1 120 to Samuel Via A. Carlotte Via G. Garden, 6, 1 120 to Samuel Via A. Carlotte Via G. Garden, 6, 1 120 to Samuel Via A. Carlotte Via G. Garden, 6, 1 120 to Samuel Via A. Carlotte Via G. Garden, 6, 1 120 to Samuel Via A. Carlotte Via G. Garden, 6, 1 120 to Samuel Via G. Gar	
Full name of second inventor Donata BENSI	
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Second inventor's signature	्राच्याः स्थापन्
	date
Residence Vercelli, ITALY	
Citizenship ITALY	
Post Office Address Via XX Settembre, 18, I-13100 Vercelli, ITALY	
Full name of third inventor Elena VISMARA	
Third inventor's signature	
Third inventor's signature When I have the signature	19-1-06
	date
Residence Milano, ITALY	
Citizenship ITALY	
Post Office Address Via G. Colombo 81/A 1-20133 Milano ITALY	